SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74175, SN74LS174, SN74LS175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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'174, 'LS174, 'S174 . . . HEX D-TYPE FLIP-FLOPS '175, 'LS175, 'S175 . . . QUADRUPLE D-TYPE FLIP-FLOPS

- '174, 'LS174, 'S174 Contain Six Flip-Flops with Single-Rail Outputs
- '175, 'LS175, 'S175 Contain Four Flip-Flops with Double-Rail Outputs
- Three Performance Ranges Offered: See Table Lower Right
- Buffered Clock and Direct Clear Inputs
- Individual Data Input to Each Flip-Flop
- Applications include: Buffer/Storage Registers Shift Registers

Pattern Generators

description

These monolithic, positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic. All have a direct clear input, and the '175, 'LS175, and 'S175 feature complementary outputs from each flipflop.

Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect at the output.

These circuits are fully compatible for use with most TTL circuits.

FUNCTION TABLE												
(EACH FLIP-FLOP)												
	INPUTS (
CLEAR	CLOCK	D	Q	ā۲								
L	x	х	L	н								
н	1	н	н	L								
н	Ť	L	L	н								
н	L	х	۵ ₀	ā0								

H = high level (steady state)

L = low level (steady state)

X = irrelevant

t = transition from low to high level

 Q_0 = the level of Q before the indicated steady-state

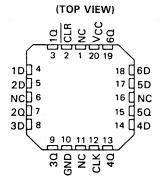
input conditions were established. † = '175, 'LS175, and 'S175 only

,,		
	TYPICAL	TYPICAL
TYPES	MAXIMUM	POWER
11723	CLOCK	DISSIPATION
	FREQUENCY	PER FLIP-FLOP
'174, '175	35 MHz	38 mW
'LS174, 'LS175	40 MHz	14 mW
'S174, 'S175	110 MHz	75 mW

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

SN54174, SN54LS174, SN54S174 J OR W PACKAGE
SN74174 N PACKAGE
SN74LS174, SN74S174 D OR N PACKAGE

SN54LS174, SN54S174 . . . FK PACKAGE

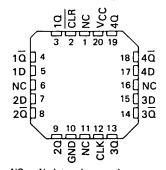


SN54175, SN54LS175, SN54S175...J OR W PACKAGE SN74175...N PACKAGE

SN74LS175, SN74S175...D OR N PACKAGE (TOP VIEW)

•		•
	hτ	
10[2	15 40
١āĽ	3	14 🛛 40
1 D 🗌	4	13 🗍 4 D
2 D 🗌	5	12 🗍 3 D
2 <u>0</u> [6	11]] 30
20]7	10 🛛 30.
GND	8	9 СLК

SN54LS175, SN54S175 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

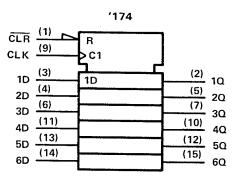
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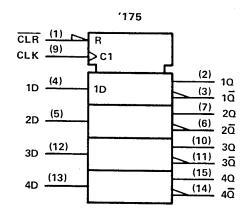
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SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74175, SN74LS174, SN74LS175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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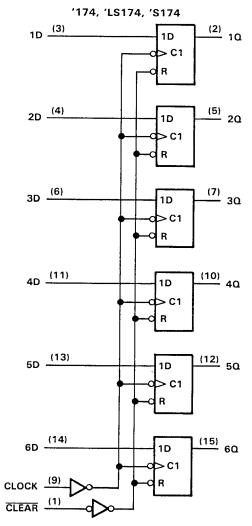
logic symbols[†]





[†]These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

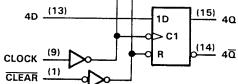
logic diagrams (positive logic)



1D <u>(4)</u> <u>(2)</u> 10 1D > C1<u>(3)</u> 10 R (7) 20 (5) 2D 1D > C1 <u>(6)</u> 20 R 3D (12) (10) 30 1D ⊳cı <u>(11)</u> 30 R 4D (13) 1D

'175, 'LS175, 'S175

۰.



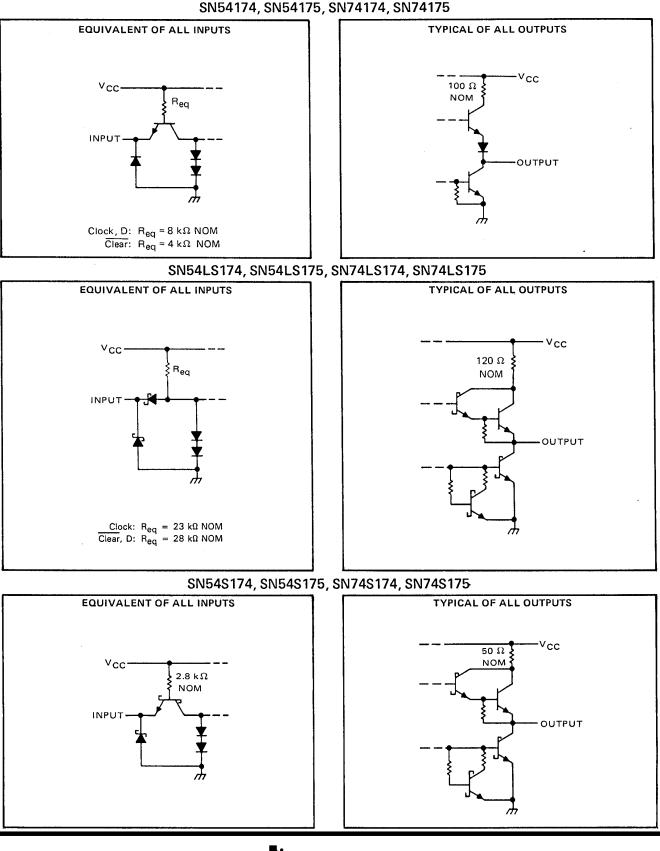
Pin numbers shown are for D, J, N, and W packages.



SN54174, SN54175, SN54LS174, SN54LS175, SN54S174, SN54S175, SN74174, SN74175, SN74LS174, SN74LS175, SN74S174, SN74S175 **HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR**

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schematics of inputs and outputs





SN54174, SN54175, SN74174, SN74175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

absolute maximum ratings over operating free-air temperature r	ange (unless otherwise noted)
Supply voltage, V _{CC} (see Note 1)	
Input voltage	
Operating free-air temperature range: SN54174, SN54175 Circuits	
SN74174, SN74175 Circuits	$ 0^{\circ}$ C to 70 $^{\circ}$ C
Storage temperature range	$\dots \dots $

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54	174, SN	54175	64175 SN74174, SN74175			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-800			-800	μA
Low-level output current, IOL				16	[16	mA
Clock frequency, fclock		0		25	0		25	MHz
Width of clock or clear pulse, tw		20			20			ns
Cotum time t	Data input	20			20			ns
Setup time, t _{su}	Clear inactive-state	25			25			ns
Data hold time, t _h		5			5			ns
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIC	NS [†]	MIN	ΤΥΡ ‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
VIK	Input clamp voltage	$V_{CC} = MIN, I_I = -12$	mA			-1.5	V
V _{ОН}	High-level output voltage	V _{CC} = MIN, V _{IH} = 2 V _{IL} = 0.8 V, I _{OH} = -		2.4	3.4		v
VOL	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V _{IL} = 0.8 V, I _{OL} = 16	,				v
-μ	Input current at maximum input voltage	V _{CC} = MAX, V ₁ = 5.5	V			1	mA
Чн	High-level input current	V _{CC} = MAX, V _I = 2.4	V			40	μA
կլ	Low-level input current	$V_{CC} = MAX, V_I = 0.4$	V			-1.6	mA
1.			SN54'	-20		-57	
los	Short-circuit output current §	V _{CC} = MAX	SN74'	-18		-57	mA
1	Current		2 '174		45	65	
1CC	Supply current	V _{CC} = MAX, See Note	2 /175		30	45	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C.

\$ Not more than one output should be shorted at a time.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{max}	Maximum clock frequency		25	35		MHz
A	Propagation delay time, low-to-high-level output from clear			16	25	ns
tplh	(SN54175, SN74175 only)	$C_{L} = 15 \text{pF},$		10	25	115
^t PHL	Propagation delay time, high-to-low-level output from clear	R _L = 400 Ω, 		23	35	ns
^t PLH	Propagation delay time, low-to-high-level output from clock	See Note 3		20	30	ns
tPHL	Propagation delay time, high-to-low-level output from clock			24	35	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



SN54LS174, SN54LS175, SN74LS174, SN74LS175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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absolute maximum ratings over operating free-air temperature range	(un	le	SS	ot	he	rw	ise	e n	101	tec	1)			÷	
Supply voltage, V _{CC} (see Note 1)		•						•			•		•	•	7 V
Input voltage															
Operating free-air temperature range: SN54LS174, SN54LS175 Circuits							•		•			-55	5°C	c to	125°C
SN74LS174, SN74LS175 Circuits			. '										0°	'C to	o 70°C
Storage temperature range		•	•	•	•	•	•	•	•	•		-65	5°C	C to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN	154LS1	74	SN	UNIT		
		SI	V54LS1	75	SN			
		MIŅ	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH				-400			-400	μA
Low-level output current, IOL	· · · · · · · · · · · · · · · · · · ·			4			8	mA
Clock frequency, fclock		0		30	0		30	MHz
Width of clock or clear pulse, t _w		20			20			ns
Setup time, t _{su}	Data input	20			20			ns
Setup time, t _{su}	Clear inactive-state	25			25			ns
Data hold time, t _h		5			5			ns
Operating free-air temperature, T _A		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS [†]			-	N54LS1 N54LS1		S S	UNIT		
		1			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIH	High-level input voltage				2			2		~~~	V
VIL	Low-level input voltage						0.7			0.8	V
٧ _{IK}	Input clamp voltage	V _{CC} = MIN,	l ₁ = -18 mA				-1.5			-1.5	V
v _{он}	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max	V _{IH} = 2 V, I _{OH} = -400 μA	λ	2.5	3.5		2.7	3.5		v
Vol	Low-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max		IOL = 4 mA		0.25	0.4		0.25 0.35	0.4	V
łı	Input current at maximum input voltage	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
Чн	High-level input current	V _{CC} = MAX,	V _I = 2.7 V				20			20	μA
կլ	Low-level input current	V _{CC} = MAX,	V ₁ = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current §	V _{CC} = MAX			-20		100	-20		-100	mA
Icc	Supply current	Vcc = MAX,	See Note 2	'LS174		16	26		16	26	mA
			VCC - MAX, See Note 2 'L			11	18		11	18	

¹For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 \ddagger All typical values are at V_{CC} = 5 V, T_A = 25°C.

\$Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, I_{CC} is measured after a momentary ground, then 4.5 V, is applied to clock.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PABAMETER	TEST CONDITIONS	'LS174			'LS175			
FANAMETEN	TEST CONDITIONS	MIN	түр	MAX	MIN	түр	MAX	UNIT
f _{max} Maximum clock frequency		30	40		30	40		MHz
tPLH Propagation delay time, low-to-high-level output from clear	C _L = 15 pF,					20	30	ns
tpHL Propagation delay time, high-to-low-level output from clear	$R_{\rm L} = 2 k \Omega$,		23	35	t	20	30	ns
tPLH Propagation delay time, low-to-high-level output from clock	See Note 3		20	30		13	25	ns
tphL Propagation delay time, high-to-low-level output from clock	1		21	30		16	25	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



SN54S174, SN54S175, SN74S174, SN74S175 HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range: SN54S174, SN54S175 Circuits	
SN74S174, SN74S175 Circuits	$ 0^{\circ}$ C to 70°C
Storage temperature range	$65^{\circ}C$ to $150^{\circ}C$

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54S174, SN54S175			SN74S174, SN74S175			LINUT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH	······			-1			-1	mA
Low-level output current, IOL				20			20	mA
Clock frequency, fclock		0		75	0		75	MHz
Pulso width t	Clock	7			7			
Pulse width, t _w	Clear	10			10			ns
Catura time, t	Data input	5			5			
Setup time, t _{su}	Clear inactive-state	5			5			ns
Data hold time, t _h		3			3			ns
Operating free-air temperature, TA		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]		MIN	түр‡	MAX	UNIT
VIH	High-level input voltage			2			V
VIL	Low-level input voltage					0.8	V
VIK	Input clamp voltage	V _{CC} = MIN, I ₁ =18 mA				-1.2	V
VOH High-level output voltage	$V_{CC} = MIN, V_{1H} = 2V,$	SN54S'	2.5	3.4			
	Hign-level output voltage	V _{IL} = 0.8 V, I _{OH} = -1 mA	SN74S'	2.7	3.4		V
VOL Low-level output voltage		$V_{CC} = MIN, V_{IH} = 2 V,$	· · · · · · · · · · · · · · · · · · ·			0.5	V
	V _{IL} = 0.8 V, I _{OL} = 20 mA				0.5	V	
lj –	Input current at maximum input voltage	V _{CC} = MAX, V _I = 5.5 V				1	mA
ЧΗ	High-level input current	V _{CC} = MAX, V ₁ = 2.7 V				50	μA
[↓] IL	Low-level input current	V _{CC} = MAX, V _I = 0.5 V				-2	mA
los	Short-circuit output current §	V _{CC} = MAX		-40		-100	mA
1	Supply current	117	'174		90	144	
		V _{CC} = MAX, See Note 2 '175			60	96	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device type.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. [§]Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: With all outputs open and 4.5 V applied to all data and clear inputs, ICC is measured after a momentary ground, then 4.5 V, is applied to clock.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	MIN	түр	MAX	UNIT
f _{max}	Maximum clock frequency		75	110		MHz
^t PLH	Propagation delay time, low-to-high-level $\overline{\Omega}$ output from clear (SN54S175, SN74S175 only)	С _L = 15 рF,		10	15	ns
tрнц	Propagation delay time, high-to-low-level Q output from clear	$R_{L} = 280 \Omega,$		13	22	ns
₽LH	Propagation delay time, low-to-high-level output from clock	See Note 3		8	12	ns
^t PHL	Propagation time, high-to-low-level output from clock			11.5	17	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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